

December 1994

54F/74F38 Quad Two-Input NAND Buffer (Open Collector)

General Description

This device contains four independent gates, each of which performs the logic NAND function. The open-collector outputs require external pull-up resistors for proper logical operation.

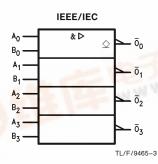
Commercial	Military	Package Number	Package Description		
74F38PC		N14E	14-Lead (0.300" Wide) Molded Dual-In-Line		
	54F38DM (Note 2)	J14A	14-Le <mark>ad Ceramic Dua</mark> l-In-Line		
74F38SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC		
74F38SJ (Note 1)	1.73	M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ		
	54F38FM (Note 2)	W14B	14-Lead Cerpack		
	54F38LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C		

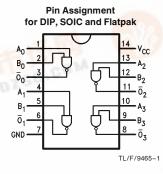
Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

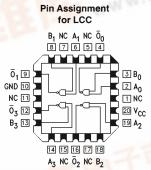
Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbol

Connection Diagrams







TL/F/9465-2

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Unit Loading/Fan Out

		54F/74F				
Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}			
A_n, B_n \overline{O}_n	Inputs Outputs	1.0/2.0 OC*/106.6 (80)	20 μA/ – 1.2 mA OC*/64 mA (48 mA)			

^{*}OC = Open Collector

Function Table

Inp	uts	Output			
Α	В	ō			
L	L	Н			
L	Н	Н			
Н	L	Н			
Н	Н	L			

H = HIGH Voltage Level

L = LOW Voltage Level

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

-65°C to +150°C Storage Temperature Ambient Temperature under Bias -55°C to +125°C Junction Temperature under Bias -55°C to +175°C −55°C to +150°C

V_{CC} Pin Potential to

Plastic

Ground Pin $-0.5\mbox{V}$ to $+7.0\mbox{V}$ -0.5V to +7.0VInput Voltage (Note 2) Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with $V_{CC} = 0V$)

 $-0.5\mbox{V}$ to $\mbox{V}_{\mbox{CC}}$ Standard Output TRI-STATE® Output -0.5V to +5.5V

Current Applied to Output

in LOW State (Max) twice the rated I_{OL} (mA)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature

-55°C to +125°C Military Commercial 0° C to $+70^{\circ}$ C

Supply Voltage

+4.5V to +5.5VMilitary +4.5V to +5.5V Commercial

DC Electrical Characteristics

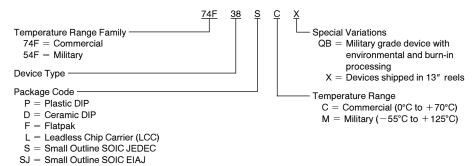
Symbol	Parameter		54F/74F			Units	v _{cc}	Conditions		
Symbol			Min	Тур	Max	Onits	VCC	Conditions		
V _{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal		
V _{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal		
V _{CD}	Input Clamp Diode Vo	oltage			-1.2	V	Min	$I_{\text{IN}} = -18 \text{ mA}$		
V _{OL}	Output LOW Voltage	54F 10% V _{CC} 74F 10% V _{CC}			0.55 0.55	٧	Min	$I_{OL} = 48 \text{ mA}$ $I_{OL} = 64 \text{ mA}$		
I _{IH}	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	V _{IN} = 2.7V		
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V _{IN} = 7.0V		
V _{ID}	Input Leakage Test	74F	4.75			V	0.0	$I_{\text{ID}} = 1.9 \ \mu\text{A}$ All Other Pins Grounded		
l _{OD}	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V _{IOD} = 150 mV All Other Pins Grounded		
I _{IL}	Input LOW Current				-1.2	mA	Max	$V_{IN} = 0.5V$		
Гонс	Open Collector, Output OFF Leakage Test				250	μΑ	Min	$V_{OUT} = V_{CC}$		
I _{CCH}	Power Supply Current			2.1	7.0	mA	Max	V _O = HIGH		
I _{CCL}	Power Supply Current	t		26.0	30.0	mA	Max	$V_O = LOW$		

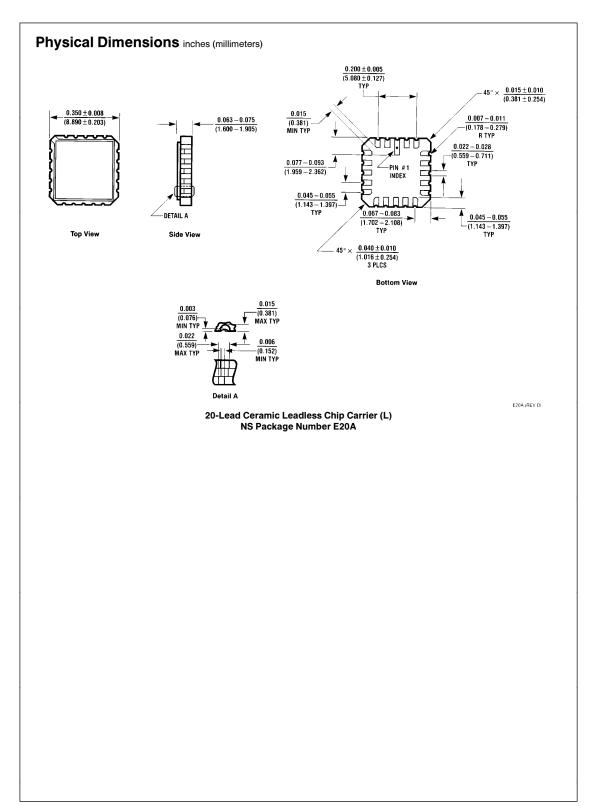
AC Electrical Characteristics

	Parameter	$74F$ $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			5	4F	74F		
Symbol					$ extsf{T}_{ extsf{A}}, extsf{V}_{ extsf{CC}} = extsf{Mil} \ extsf{C}_{ extsf{L}} = extsf{50 pF}$		$ extsf{T}_{ extsf{A}}, extsf{V}_{ extsf{CC}} = extsf{Com} \ extsf{C}_{ extsf{L}} = extsf{50 pF}$		Units
		Min	Тур	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay	6.5	9.7	12.5	6.5	14.5	6.5	13.0	no
t _{PHL}	A_n , B_n to \overline{O}_n	1.5	2.1	5.0	1.0	5.5	1.5	5.5	ns

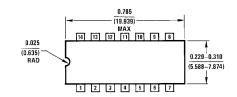
Ordering Information

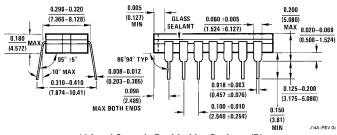
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



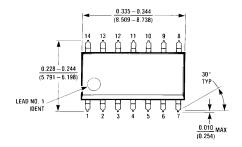


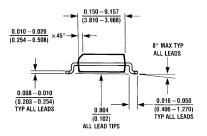
Physical Dimensions inches (millimeters) (Continued)

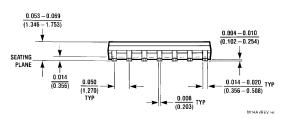




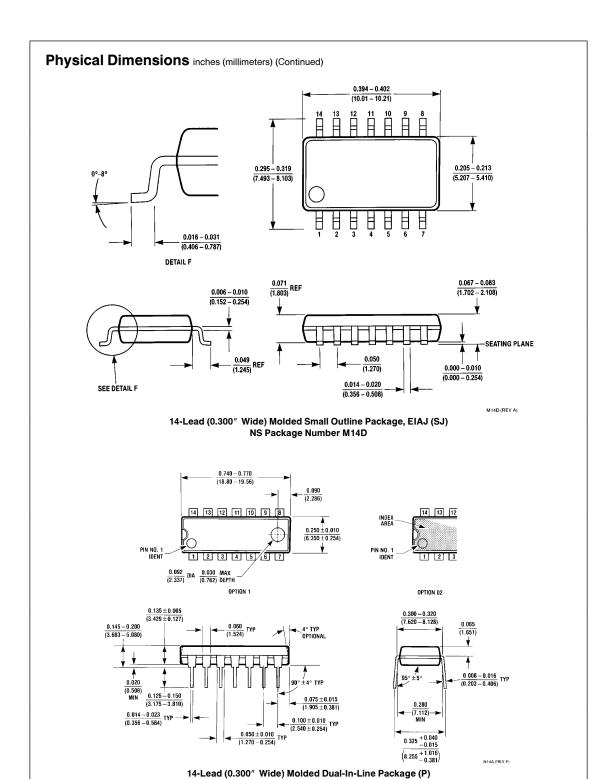
14-Lead Ceramic Dual-In-Line Package (D) NS Package Number J14A





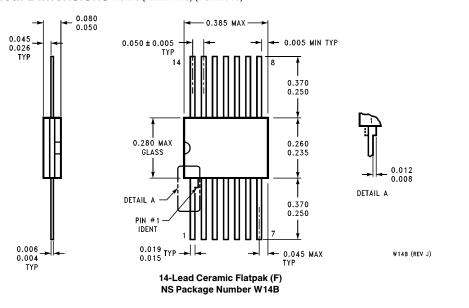


14-Lead (0.150" Wide) Molded Small Outline Package, JEDEC (S)
NS Package Number M14A



NS Package Number N14A

Physical Dimensions inches (millimeters) (Continued)



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